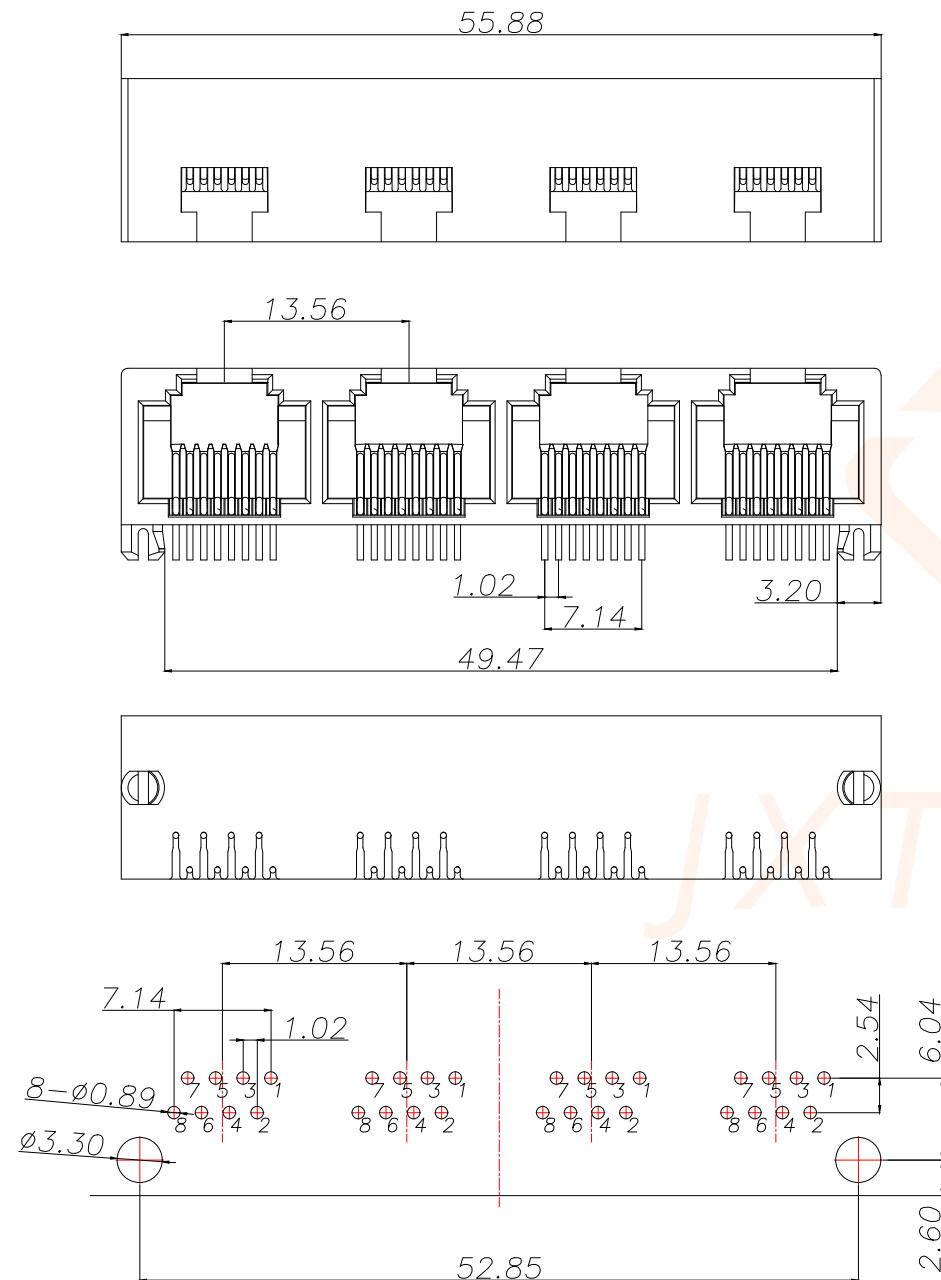
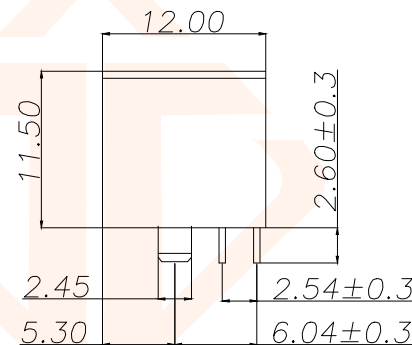
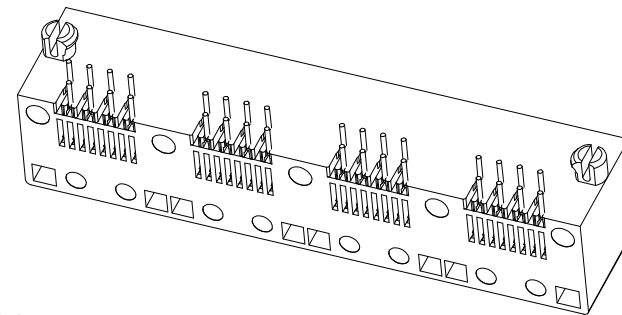




REV.	ECN NO.	DESCRIPTION	DATE	DESIGN



PCB LAYOUT T=1.6
TOP VIEW TOL:±0.05



NOTES

MATERIAL

- 1.HOUSING MATERIAL: THERMO PLASTICS UL94V-0.
- 2.CONTACT MATERIAL: PHOSPHOR BRONZE $\phi 0.46\text{mm}$.
- 3.PLATING: GOLD PLATING OVER NICKEL.

ELECTRICAL

- 1.VOLTAGE RATING: 125 VAC RMS.
- 2.CURRENT RATING: 1.5 AMP.
- 3.CONTACT RESISTANCE: 40 MILLIOHMS MAX.
- 4.INSULATION RESISTANCE: 500 MEGOHMS MIN @ 100V DC .
- 5.DIELECTRIC DIELECTRIC RESISTANCE: 500V DC RMS 50Hz. 1MIN.

MECHANICAL

- 1.DURRABILITY: 750 CYCLES MIN.
2. MATING/UNMATING FORC: 2.24 KG.F MAX.

ENVIRONMENTAL:

- 1.OPERATION: $-40^{\circ}\text{C}\sim+85^{\circ}\text{C}$.
- 2.STORAGE: $-40^{\circ}\text{C}\sim+85^{\circ}\text{C}$.

TOLERANCE		深圳聚兴泰电子科技有限公司 Shenzhen Juxingtai Electronic Technology Co., Ltd			
X.:±0.35	X':±3"	PART NO. RJ45-2020-32P	TITLE: 5301 1x4 全塑 DIP B款		
X.X:±0.25	X.X':±2"		MANUFACTURE DWG		
X.XX:±0.15	X.XX':±1"				
UNITS	mm	DESIGN:	Ethan		
MATERILA	— — —	CHED:	Olvia		
FINISH	— — —	APPD:	Ava		
				SCALE N:A	SHEET 1/1